

## **STPS30100ST**

## Power Schottky rectifier

### Main product characteristics

I <sub>F(AV)</sub>	30 A
V <sub>RRM</sub>	100 V
T <sub>j</sub> (max)	150° C
V <sub>F</sub> (typ)	0.385 V

#### **Features and Benefits**

- Avalanche rated
- Low V<sub>F</sub>
- Good trade off between leakage current and forward voltage drop
- High frequency operation
- Avalanche capability specified

### **Description**

Single Schottky rectifier, suited for high frequency switch mode power supply.

Packaged in TO-220AB, this device is intended to be used in notebook and game station adaptors, providing in these applications a good efficiency at both low and high load.

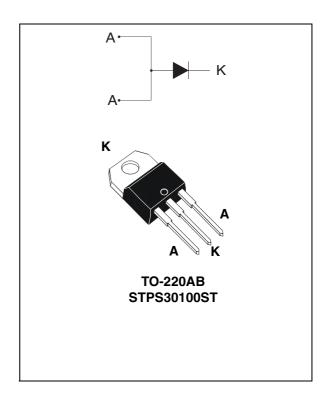


Table 1. Absolute Ratings (limiting values)

Symbol	Paramet	Value	Unit	
V <sub>RRM</sub>	Repetitive peak reverse voltage		100	V
I <sub>F(RMS)</sub>	RMS forward current		60	Α
I <sub>F(AV)</sub>	Average forward current $\delta = 0.5$	T <sub>c</sub> = 125° C	30	Α
I <sub>FSM</sub>	Surge non repetitive forward current	t <sub>p</sub> = 10 ms sinusoidal	300	Α
P <sub>ARM</sub>	Repetitive peak avalanche power	$t_p = 1 \mu s T_j = 25^{\circ} C$	26400	W
T <sub>stg</sub>	Storage temperature range	-65 to + 175	°C	
T <sub>j</sub>	Maximum operating junction temperature	150	°C	

<sup>1.</sup>  $\frac{dPtot}{dT_i} < \frac{1}{Rth(i-a)}$  condition to avoid thermal runaway for a diode on its own heatsink

Characteristics **STPS30100ST** 

#### **Characteristics** 1

Table 2. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>th(j-c)</sub>	Junction to case	1	°C/W

Table 3. Static electrical characteristics (per diode)

Symbol	Parameter	Test Cor	Min.	Тур.	Max.	Unit	
I <sub>R</sub> <sup>(1)</sup> Reverse leakag		T <sub>j</sub> = 25° C	$V_R = V_{RRM}$			175	μΑ
	Pavaraa laakaga gurrant	T <sub>j</sub> = 125° C			20	50	mA
'R` ′	I <sub>R</sub> <sup>(1)</sup> Reverse leakage current	T <sub>j</sub> = 25° C	\/ 70.\/			60	μΑ
l		T <sub>j</sub> = 125° C	$V_R = 70 \text{ V}$		10	20	mA
		T <sub>j</sub> = 25° C	I <sub>F</sub> = 5 A		0.475		
	T <sub>j</sub> = 125° C	I IF - J A		0.385			
		$T_j = 25^{\circ} C$	I <sub>F</sub> = 10 A		0.555		
V <sub>F</sub> <sup>(2)</sup> Forward voltage drop	T <sub>j</sub> = 125° C	IF - 10 A		0.475		V	
	$T_j = 25^{\circ} C$	I <sub>F</sub> = 15 A		0.620	0.660	V	
		T <sub>j</sub> = 125° C	] IF = 13 A		0.525	0.565	
		$T_j = 25^{\circ} C$	I <sub>F</sub> = 30 A		0.740	0.800	
		T <sub>j</sub> = 125° C			0.605	0.655	

<sup>1.</sup> Pulse test:  $t_p = 5 \text{ ms}, \delta < 2\%$ 

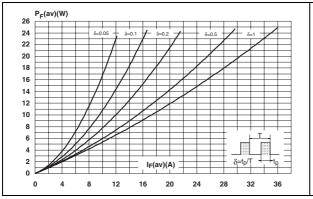
To evaluate the conduction losses use the following equation: P = 0.475 x  $I_{F(AV)}$  + 0.006 x  $I_{F}^{2}_{(RMS)}$ 

$$P = 0.475 \times I_{F(AV)} + 0.006 \times I_{F^{2}(RMS)}$$

<sup>2.</sup> Pulse test:  $t_p$  = 380  $\mu$ s,  $\delta$  < 2%

STPS30100ST Characteristics

Figure 1. Conduction losses versus average Figure 2. Average forward current versus ambient temperature ( $\delta$  = 0.5)



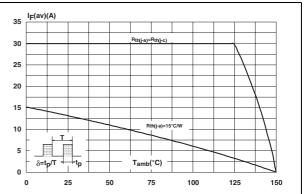


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

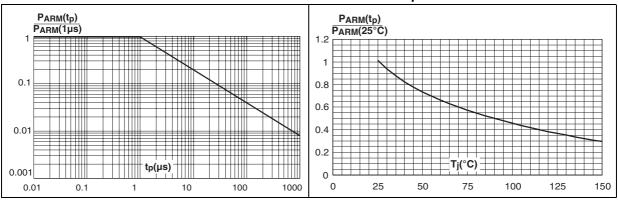
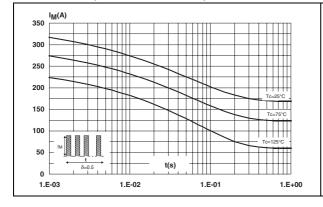
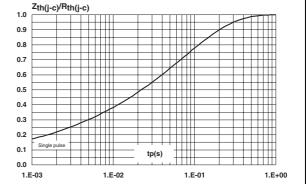


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 6. Relative variation of thermal impedance junction to case versus pulse duration

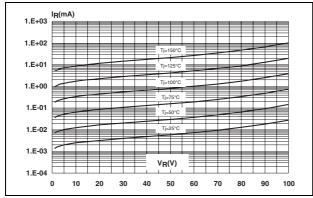




Characteristics STPS30100ST

Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

Figure 8. Junction capacitance versus reverse voltage applied (typical values)



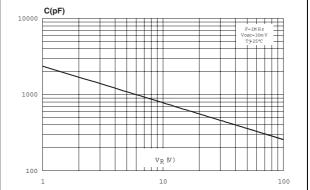
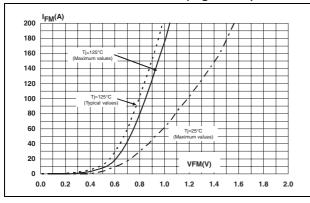
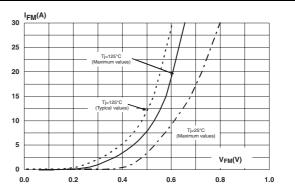


Figure 9. Forward voltage drop versus forward current (high level)

Figure 10. Forward voltage drop versus forward current (low level)



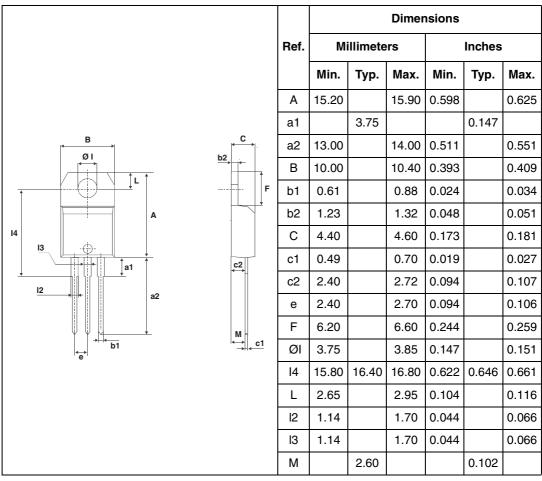


STPS30100ST Package Information

## 2 Package Information

Epoxy meets UL94,V0

Table 4. TO-220AB dimensions



In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

**577** 

Ordering Information STPS30100ST

# **3 Ordering Information**

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
STPS30100ST	STPS30100ST	TO-220AB	2.23 g	50	Tube

# 4 Revision History

Date	Revision	Changes
24-Oct-2006	1	First issue

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2006 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

